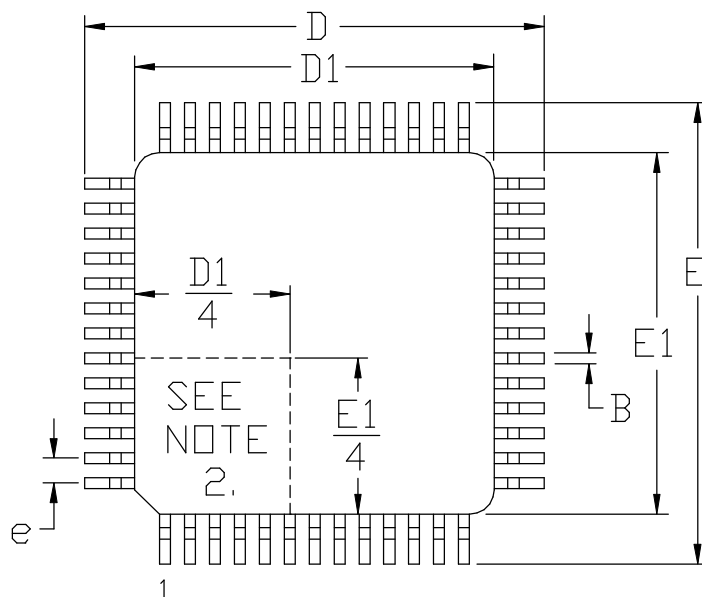
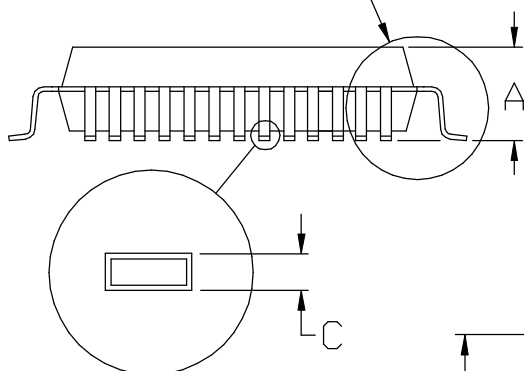




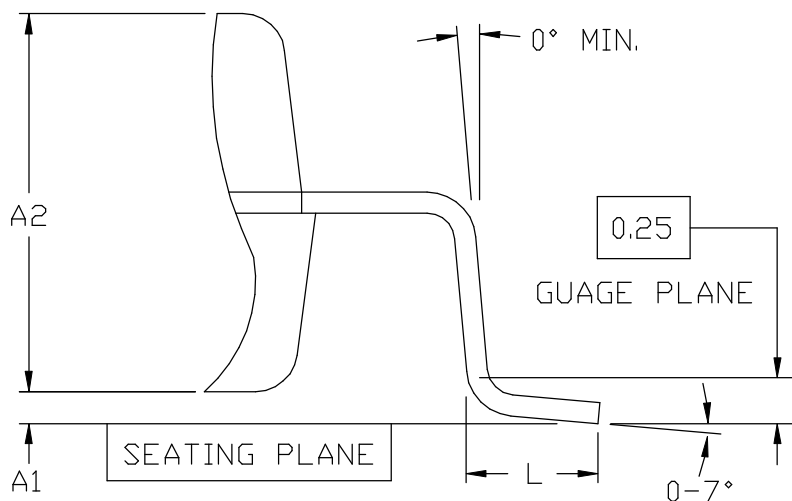
SEE DETAIL "A"



NOTES:

1. DIMENSIONS D1 AND E1 INCLUDE MOLD MISMATCH, BUT DO NOT INCLUDE MOLD PROTRUSION; ALLOWABLE PROTRUSION IS 0.25 MM PER SIDE.
2. DETAILS OF PIN 1 IDENTIFIER ARE OPTIONAL BUT MUST BE LOCATED WITHIN THE ZONE INDICATED.
3. ALLOWABLE DAMBAR PROTRUSION IS 0.08 MM TOTAL IN EXCESS OF THE B DIMENSION; PROTRUSION NOT TO BE LOCATED ON LOWER RADIUS OR FOOT OF LEAD.

DIM	MIN	MAX
A	—	2.45
A1	0.25	—
A2	1.95	2.10
B	0.22	0.38
C	0.13	0.23
D	12.95	13.45
D1	9.90	10.10
E	12.95	13.45
E1	9.90	10.10
e	0.65 BSC	
L	0.65	1.03



DETAIL A

DIMENSIONS ARE IN MILLIMETERS

SIGNATURE		DATE		 Dallas Semiconductor TITLE MARKETING OUTLINE, 52 LD. QFP, 10X10X2 BODY, 1.6/0.3 FORM			
DOC. CONTROL:							
ENGR. MGR:							
MFG. ENGR:							
CHECKED BY:							
DRAWN BY:		SIZE A	FSCM NO	PART NO.	REV A		
DO NOT SCALE DWG.		SCALE N/A		SHEET 1 OF 1			